

# STBV32

# High voltage fast-switching NPN power transistor

## Features

- High voltage capability
- Low spread of dynamic parameters
- Minimum lot-to-lot spread for reliable operation
- Very high switching speed

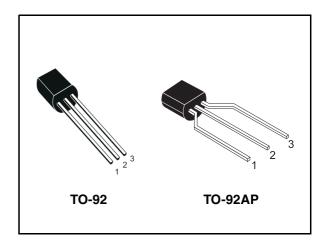
## **Applications**

- Compact fluorescent lamps (CFLS)
- SMPS for battery charger

## Description

The device is manufactured using high voltage multi epitaxial planar technology for high switching speeds and high voltage capability. It uses a cellular emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

The STBV32G and STBV32G-AP are supplied using halogen-free molding compound.



### Figure 1. Internal schematic diagram

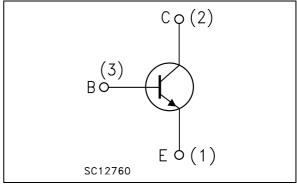


Table 1. Device sum	mary
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Order codes	Marking	Package	Packaging
STBV32	BV32	TO-92	Bulk
STBV32G	BV32G	TO-92	Bulk
STBV32-AP	BV32	TO-92AP	Ammopack
STBV32G-AP	BV32G	TO-92AP	Ammopack

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# 1 Electrical ratings

Table 2.	Absolute	maximum	rating

Symbol	Parameter	Value	Unit	
V <sub>CES</sub>	Collector-emitter voltage (V <sub>BE</sub> = 0)	700	V	
V <sub>CEO</sub>	Collector-emitter voltage $(I_B = 0)$	400	V	
$V_{EBO}$	Collector-base voltage (I <sub>C</sub> = 0, I <sub>B</sub> = 0.5A, t <sub>P</sub> < 10 ms)	V <sub>(BR)EBO</sub>	V	
Ι <sub>C</sub>	Collector current (f $\geq$ 100 Hz, duty-cycle $\leq$ 50%, T <sub>C</sub> = 25 °C)	1.5	A	
I <sub>CM</sub>	Collector peak current (t <sub>P</sub> < 5 ms)	3	A	
I <sub>B</sub>	Base current	0.5	А	
I <sub>BM</sub>	Base peak current (t <sub>P</sub> < 5 ms)	1.5	A	
P <sub>TOT</sub>	Total dissipation at $T_c = 25 \text{ °C}$	1.5	W	
T <sub>stg</sub>	Storage temperature	-65 to 150	°C	
Т <sub>Ј</sub>	Max. operating junction temperature	150		

### Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	83.3	°C/W

# 2 Electrical characteristics

( $T_{case} = 25 \ ^{\circ}C$ ; unless otherwise specified)

Table 4.	Electrical	characteristics

Symbol	Parameter	Test co	nditions	Min.	Тур.	Max.	Unit
I <sub>CES</sub>	Collector cut-off current (V <sub>BE</sub> = 0)	V <sub>CE</sub> = 700 V V <sub>CE</sub> = 700 V	T <sub>C</sub> = 125 °C			1 5	mA mA
V <sub>(BR)EBO</sub>	Emitter-base breakdown voltage (I <sub>C</sub> = 0)	l <sub>E</sub> = 10 mA		9		18	۷
V <sub>CEO(sus)</sub> <sup>(1)</sup>	Collector-emitter sustaining voltage ( $I_B = 0$ )	l <sub>C</sub> = 10 mA		400			V
V <sub>CE(sat)</sub> <sup>(1)</sup>	Collector-emitter saturation voltage	$I_{\rm C} = 0.5 \text{ A}$ $I_{\rm C} = 1 \text{ A}$ $I_{\rm C} = 1.5 \text{ A}$	I <sub>B</sub> = 250 mA			0.5 1 1.5	V V V
V <sub>BE(sat)</sub> <sup>(1)</sup>	Base-emitter saturation voltage	I <sub>C</sub> = 0.5 A I <sub>C</sub> = 1 A	l <sub>B</sub> = 100 mA l <sub>B</sub> = 250 mA			1 1.2	V V
h <sub>FE</sub>	DC current gain	$I_{\rm C} = 0.5 \text{ mA}$ $I_{\rm C} = 0.5 \text{ A}$ $I_{\rm C} = 1 \text{ A}$	•=	20 8 5		25 25	
t <sub>r</sub> t <sub>s</sub> t <sub>f</sub>	Resistive load Rise time Storage time Fall time	$I_{C} = 1 \text{ A}$ $I_{B1} = -I_{B2} = 200 \text{ r}$ $V_{CC} = 125 \text{ V}$				1 4 0.7	μs μs μs
t <sub>s</sub>	Inductive Load Storage time	$I_{C} = 1 A$ $I_{B1} = 200 mA$ L = 50 mH <i>Figure 13.</i>	$V_{clamp} = 300 V$ $V_{BE(off)} = -5 V$ $R_{BB} = 0$		0.8		μs

1. Pulsed duration = 300  $\mu$ s, duty cycle  $\leq$ 1.5%



GC57293

T<sub>c</sub> (℃)

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## 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

## Figure 3. Derating curve

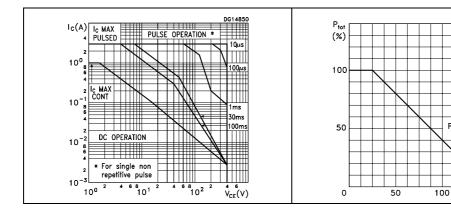


Figure 4. Output characteristics

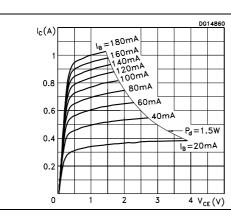
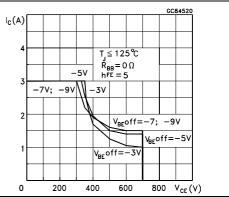


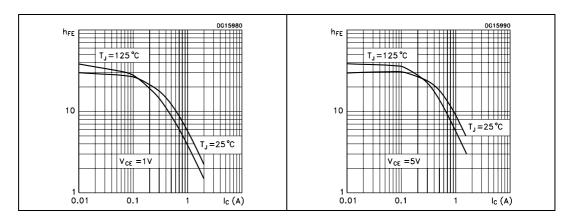


Figure 5. Reverse biased safe operating area



P<sub>tot</sub>





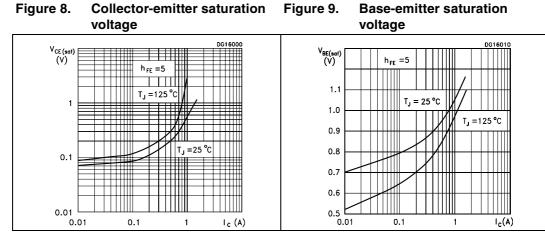
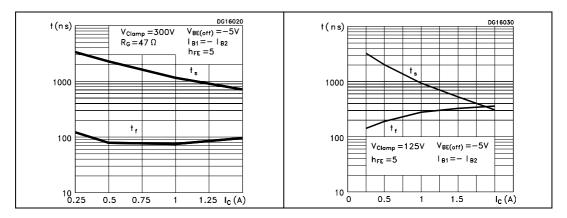
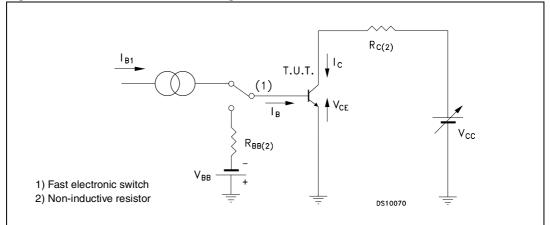


Figure 10. Inductive load switching time Figure 11. Resistive load switching time



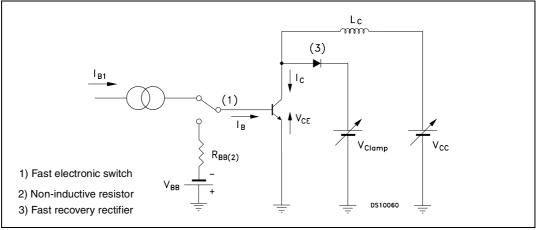


## 2.2 Test circuits



## Figure 12. Resistive load switching test circuit

## Figure 13. Inductive load switching test circuit



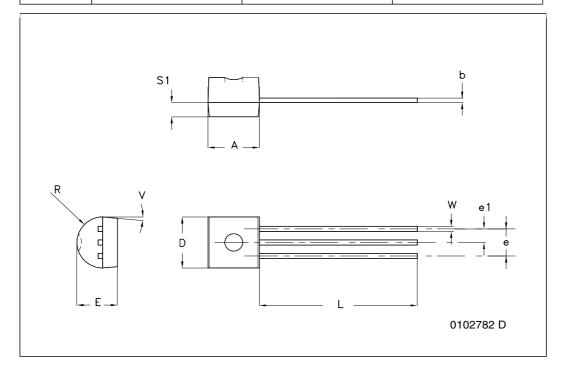
# 3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



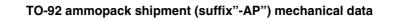
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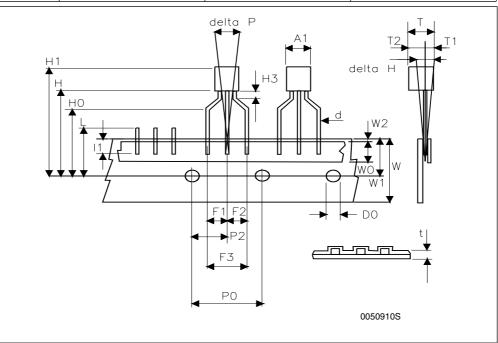
	TO-92 bulk shipment mechanical data		
		mm.	
DIM.	MIN.	ТҮР	MAX.
А	4.32		4.95
b	0.36		0.51
D	4.45		4.95
E	3.30		3.94
е	2.41		2.67
e1	1.14		1.40
L	12.70		15.49
R	2.16		2.41
S1	0.92		1.52
w	0.41		0.56
V		5 <sup>0</sup>	



### 8/11

Dim.		mm	
Dim.	Min	Тур	Мах
A1			4.80
Т			3.80
T1			1.60
T2			2.30
d			0.48
P0	12.50	12.70	12.90
P2	5.65	6.35	7.05
F1,F2	2.44	2.54	2.94
F3	4.98	5.08	5.48
delta H	-2.00		2.00
W	17.50	18.00	19.00
W0	5.70	6.00	6.30
W1	8.50	9.00	9.25
W2			0.50
н	18.50		20.50
H3	0.5	1	1.5
H0	15.50	16.00	16.50
H1			25.00
D0	3.80	4.00	4.20
t			0.90
L			11.00
11	3.00		
delta P	-1.00		1.00





# 4 Revision history

## Table 5.Document revision history

Date	Revision	Changes
02-Jul-2008	8	Added halogen-free molding compound package.



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